

Final Product/Process Change Notification Document #:FPCN25451X

Issue Date:02 Apr 2024

Title of Change:	Qualification of onsemi Aizu Japan as wafer Fab for ONC25 Technology for select products from NCS20061, NCS20081, NCS20091 and NCS20062, NCS20082, NCS20092.			
Proposed First Ship date:	09 Jul 2024 or earlier if approved by customer			
Contact Information:	Contact your local onse	emi Sales Office or Adrian.Croitoru@onsemi.com		
PCN Samples Contact:	Contact your local onsemi Sales Office. Sample requests are to be submitted no later than 30 days from the date of first notification, Initial PCN or Final PCN, for this change. Samples delivery timing will be subject to request date, sample quantity and special customer packing/label requirements.			
Additional Reliability Data:	Contact your local onse	emi Sales Office or Vladislav.Hrachovec@onsemi.com		
Type of Notification:	This is a Final Product/Process Change Notification (FPCN) sent to customers. FPCNs are issued 90 days prior to implementation of the change. onsemi will consider this change accepted, unless an inquiry is made in writing within 30 days of delivery of this notice. To do so, contact PCN.Support@onsemi.com			
Marking of Parts/ Traceability of Change:	Custom source information identified by encoded	ation will be updated on product label. Product traceability will be date code.		
Change Category:	Assembly Change, Wafer Fab Change			
Change Sub-Category(s):	Manufacturing Site Ad	dition, Material Change		
Sites Affected:				
onsemi Sites		External Foundry/Subcon Sites		
onsemi Aizu, Japan		UTAC, Thailand		
onsemi Carmona, Philippines				
onsemi Seremban, Malaysia				

#### Description and Purpose:

onsemi would like to inform its customers of qualification of an additional wafer fabrication facility for ONC25 technology at onsemi Aizu, Japan for the devices listed in this FPCN, and wire conversion from Au to Pd-Coated Copper (PCC). All products listed here will be dual sourced from onsemi Gresham and onsemi Aizu.

There is no change to the orderable part number.

There is no product marking change as a result of this notification.

No changes to part specification or datasheet are anticipated.

NCS20061.NCS20081.NCS20091 Products – All packages	From	То
Wafer Fab	onsemi, Gresham, Oregon (US)	onsemi, Gresham, Oregon (US); onsemi, Aizu (Japan)
Bond Wire	0.8mil Au	0.8mil Pd-Coated Copper (PCC)



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NCS20062.NCS20082.NCS20092 Products -under SOIC-8 and TSSOP-8 packages		From		То			
Wafer Fab		onser	ni, Gresham, Oregon (US)	ons		mi, Gresham, Oregon (US); onsemi, Aizu (Japan)	
Bond Wire			0.8mil Au	1n	nil Pd-Coated C	opper (PCC)	
NCS20062.NCS20082.NCS20092 Produ MICRO-8 package	icts under		From		То		
Wafer Fab		onser	ni, Gresham, Oregon (US)	ons	emi, Gresham, onsemi, Aizu		
Bond Wire			1mil Au	1n	nil Pd-Coated C	opper (PCC)	
DEVICE NAME: NCS20061MUTAG 15: S90292							
DEVICE NAME: NCS20061MUTAG IS: S90292		ation	Condition		Interval	Results	
DEVICE NAME: NCS20061MUTAG IS: S90292 CKAGE: UDFN-6	Specific JESD22-		Condition Ta=125°C, 100 % max rate	d Vcc	Interval 1008 hrs	Results 0/80	
DEVICE NAME: NCS20061MUTAG IS: S90292 CKAGE: UDFN-6 Test	Specific	-A108		d Vcc			
High Temperature Operating Life	Specific JESD22-	-A108 -A103	Ta=125°C, 100 % max rate	T, HAST	1008 hrs	0/80	
DEVICE NAME: NCS20061MUTAG IS: S90292 CKAGE: UDFN-6 <u>Test</u> High Temperature Operating Life High Temperature Storage Life	Specific JESD22- JESD22-	-A108 -A103 ESD-A113	Ta=125°C, 100 % max rated Ta= 150°C MSL 1 @ 260°C, Pre TC, uHAS	T, HAST	1008 hrs	0/80 0/240	
7 DEVICE NAME: NCS20061MUTAG NS: S90292 CKAGE: UDFN-6 High Temperature Operating Life High Temperature Storage Life Preconditioning	Specific JESD22- JESD22- J-STD-020 JE	-A108 -A103 ESD-A113 -A104	Ta=125°C, 100 % max rated Ta= 150°C MSL 1 @ 260°C, Pre TC, uHAS for surface mount pkgs o	T, HAST only	1008 hrs 1008 hrs	0/80 0/240 0/all	
7 DEVICE NAME: NCS20061MUTAG IS: S90292 CKAGE: UDFN-6 High Temperature Operating Life High Temperature Storage Life Preconditioning Temperature Cycling	Specific JESD22- JESD22- J-STD-020 JE JESD22-	-A108 -A103 ESD-A113 -A104 -A110	Ta=125°C, 100 % max rated Ta= 150°C MSL 1 @ 260°C, Pre TC, uHAS for surface mount pkgs o Ta= -55°C to +150°C	T, HAST nly bias	1008 hrs 1008 hrs 1000 cyc	0/80 0/240 0/all 0/240	
7 DEVICE NAME: NCS20061MUTAG NS: S90292 CKAGE: UDFN-6 High Temperature Operating Life High Temperature Storage Life Preconditioning Temperature Cycling Highly Accelerated Stress Test	Specific JESD22- JESD22- J-STD-020 JE JESD22- JESD22-	-A108 -A103 ESD-A113 -A104 -A110 -A118	Ta=125°C, 100 % max rated Ta= 150°C MSL 1 @ 260°C, Pre TC, uHAS for surface mount pkgs o Ta= -55°C to +150°C 130°C, 85% RH, 18.8psig,	T, HAST nly bias	1008 hrs 1008 hrs 1000 cyc 96 hrs	0/80 0/240 0/all 0/240 0/240	

#### QV DEVICE NAME: NCS20061SN2T1G RMS: S90295 PACKAGE: TSOP-5

Test	Specification	Condition	Interval	Results
High Temperature Operating Life	JESD22-A108	Ta=125°C, 100 % max rated Vcc	1008 hrs	0/80
High Temperature Storage Life	JESD22-A103	Ta= 150°C	1008 hrs	0/240
Preconditioning	J-STD-020 JESD-A113	MSL 1 @ 260°C, Pre TC, uHAST, HAST for surface mount pkgs only		0/all
Temperature Cycling	JESD22-A104	Ta= -55°C to +150°C	1000 сус	0/240
Highly Accelerated Stress Test	JESD22-A110	130°C, 85% RH, 18.8psig, bias	96 hrs	0/240
Unbiased Highly Accelerated Stress Test	ased Highly Accelerated Stress Test JESD22-A118		96 hrs	0/240
Solderability	J-STD-002	Ta = 245°C, 5 sec	-	0/45
Electrical Distribution	onsemi DataSheet	Cpk ≥ 1.67, Test @ R & C & H	-	0/90

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#### QV DEVICE NAME: NCS20061SQ3T2G RMS: S90294 PACKAGE: SC-88A

Test **Specification** Condition Interval **Results** High Temperature Operating Life 0/80 JESD22-A108 Ta=125°C, 100 % max rated Vcc 1008 hrs High Temperature Storage Life Ta= 150°C 1008 hrs 0/240 JESD22-A103 MSL 1 @ 260°C, Pre TC, uHAST, HAST Preconditioning J-STD-020 JESD-A113 0/all for surface mount pkgs only **Temperature Cycling** JESD22-A104 Ta= -55°C to +150°C 1000 cyc 0/240 **Highly Accelerated Stress Test** 0/240 JESD22-A110 130°C, 85% RH, 18.8psig, bias 96 hrs Unbiased Highly Accelerated Stress Test JESD22-A118 130°C, 85% RH, 18.8psig, unbiased 96 hrs 0/240 Solderability J-STD-002 Ta = 245°C, 5 sec 0/45 \_ **Electrical Distribution** Cpk ≥ 1.67, Test @ R & C & H -0/90 onsemi DataSheet

#### QV DEVICE NAME: NCS20062DR2G RMS: 090248, 090249, 090250, 090252 PACKAGE: SOIC-8

Test	Specification	Condition	Interval	Results
High Temperature Operating Life	JESD22-A108	Ta=125°C, 100 % max rated Vcc	1008 hrs	0/240
High Temperature Storage Life	JESD22-A103	Ta= 150°C	1008 hrs	0/240
Preconditioning	J-STD-020 JESD-A113	MSL 1 @ 260°C, Pre TC, uHAST, HAST for surface mount pkgs only		0/all
Temperature Cycling	JESD22-A104	Ta= -55°C to +150°C	1000 cyc	0/240
Highly Accelerated Stress Test	JESD22-A110	130°C, 85% RH, 18.8psig, bias	96 hrs	0/240
Unbiased Highly Accelerated Stress Test	JESD22-A118	130°C, 85% RH, 18.8psig, unbiased	96 hrs	0/240
Solderability	J-STD-002	Ta = 245°C, 5 sec	-	0/45
Electrical Distribution	onsemi DataSheet	Cpk ≥ 1.67, Test @ R & C & H	-	0/90

#### QV DEVICE NAME: NCS20062DTBR2G RMS: 090255 PACKAGE: TSSOP-8

Test	Specification	Condition	Interval	Results
High Temperature Storage Life	JESD22-A103	Ta= 150°C	1008 hrs	0/240
Preconditioning	J-STD-020 JESD-A113	MSL 1 @ 260°C, Pre TC, uHAST, HAST for surface mount pkgs only		0/all
Temperature Cycling	JESD22-A104	Ta= -55°C to +150°C	1000 сус	0/240
Highly Accelerated Stress Test	JESD22-A110	130°C, 85% RH, 18.8psig, bias	96 hrs	0/240
Unbiased Highly Accelerated Stress Test	JESD22-A118	130°C, 85% RH, 18.8psig, unbiased	96 hrs	0/240
Solderability	J-STD-002	Ta = 245°C, 5 sec	-	0/45
Electrical Distribution	onsemi DataSheet	Cpk ≥ 1.67, Test @ R & C & H	-	0/30

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#### QV DEVICE NAME: NCS20062DMR2G RMS: S90251 PACKAGE: MICRO-8

Test	Specification	Condition	Interval	Results
High Temperature Storage Life	JESD22-A103	Ta= 150°C	1008 hrs	0/240
Preconditioning	J-STD-020 JESD-A113	MSL 1 @ 260°C, Pre TC, uHAST, HAST for surface mount pkgs only		0/all
Temperature Cycling	JESD22-A104	Ta= -55°C to +150°C	1000 сус	0/240
Highly Accelerated Stress Test	JESD22-A110	130°C, 85% RH, 18.8psig, bias	96 hrs	0/240
Unbiased Highly Accelerated Stress Test	JESD22-A118	130°C, 85% RH, 18.8psig, unbiased	96 hrs	0/240
Solderability	J-STD-002	Ta = 245°C, 5 sec	-	0/45
Electrical Distribution	onsemi DataSheet	Cpk ≥ 1.67, Test @ R & C & H	-	0/30

#### **Electrical Characteristics Summary:**

Electrical characteristics are not impacted.

#### List of Affected Parts:

**Note:** Only the standard (off the shelf) part numbers are listed in the parts list. Any custom parts affected by this PCN are shown in the customer specific PCN addendum in the PCN email notification, or on the **PCN Customized Portal**.

Part Number	Qualification Vehicle
NCS20081SQ2T2G	NCS20061SQ3T2G
NCS20081SQ3T2G	NCS20061SQ3T2G
NCS20061SQ3T2G	NCS20061SQ3T2G
NCS20092DTBR2G	NCS20062DTBR2G
NCS20092DR2G	NCS20062DR2G
NCS20092DMR2G	NCS20062DMR2G
NCS20082DTBR2G	NCS20062DTBR2G
NCS20082DR2G	NCS20062DR2G
NCS20082DMR2G	NCS20062DMR2G
NCS20062DTBR2G	NCS20062DTBR2G
NCS20062DR2G	NCS20062DR2G
NCS20062DMR2G	NCS20062DMR2G
NCS20091SQ3T2G	NCS20061SQ3T2G
NCS20091SN2T1G	NCS20061SN2T1G
NCS20091SN3T1G	NCS20061SN2T1G



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NCS20091MUTAG	NCS20061MUTAG
NCS20081SN2T1G	NCS20061SN2T1G
NCS20081SN3T1G	NCS20061SN2T1G
NCS20081MUTAG	NCS20061MUTAG
NCS20061SN2T1G	NCS20061SN2T1G
NCS20061SN3T1G	NCS20061SN2T1G
NCS20061MUTAG	NCS20061MUTAG

## Appendix A: Changed Products

### PCN#: FPCN25451X Issue Date: Apr 02, 2024

### DIKG: DIGI-KEY

Product	ustomer Part Number	Qualification Vehicle	New Part Number	Replacement Supplier
NCS20081SQ2T2G		NCS20061SQ3T2G	#NONE	
NCS20061SQ3T2G		NCS20061SQ3T2G	#NONE	
NCS20092DTBR2G		NCS20062DTBR2G	#NONE	
NCS20092DR2G		NCS20062DR2G	#NONE	
NCS20092DMR2G		NCS20062DMR2G	#NONE	
NCS20082DTBR2G		NCS20062DTBR2G	#NONE	
NCS20082DR2G		NCS20062DR2G	#NONE	
NCS20082DMR2G		NCS20062DMR2G	#NONE	
NCS20062DTBR2G		NCS20062DTBR2G	#NONE	
NCS20062DR2G		NCS20062DR2G	#NONE	
NCS20062DMR2G		NCS20062DMR2G	#NONE	
NCS20091SQ3T2G		NCS20061SQ3T2G	#NONE	
NCS20091SN2T1G		NCS20061SN2T1G	#NONE	
NCS20091SN3T1G		NCS20061SN2T1G	#NONE	
NCS20091MUTAG		NCS20061MUTAG	#NONE	
NCS20081SN2T1G		NCS20061SN2T1G	#NONE	
NCS20081SN3T1G		NCS20061SN2T1G	#NONE	
NCS20081MUTAG		NCS20061MUTAG	#NONE	
NCS20061SN2T1G		NCS20061SN2T1G	#NONE	
NCS20061SN3T1G		NCS20061SN2T1G	#NONE	
NCS20061MUTAG		NCS20061MUTAG	#NONE	
NCS20081SQ3T2G		NCS20061SQ3T2G	#NONE	